Resistors



Metal Glaze™ High Power Density **Surface Mount Power Resistor**

MRC Series

- 1/2 watt in 1/8 watt package
- MRC1/2: 0.05Ω to 1.0Ω (contact factory for higher values)
- 150°C maximum operating temperature
- Superior surge handling capability
- RoHS compliant Versions available





Electrical Data

Size Code ¹	Industry Footprint	IRC Type	Max. Power Rating	Working Voltage ²	Max. Voltage	Resistance Range (ohms) ³	Tolerance (±%) ³	TCR (ppm/°C) ³	Product Catagory
С	1206	MRC1/2	1/2W @ 70°C	200	400	0.1 to 0.99	1,2,5	100	Low Range
						1.0 to 10K	1,2,5	50,100	Standard
						20 to 10K	0.25, 0.5	50,100	Tight Tolerance

MRC Applications:

The MRC1/2 will dissipate 1/2 watt at 70°C on a 1206 footprint. The MRC is recommended for applications where board real estate is a major concern. Due to high power density and superior surge handling capability, it is also recommended as a direct replacement on existing board designs where standard 1206 resistors are marginal or failing.

Environmental Data

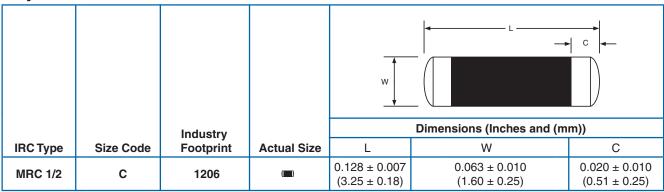
Characteristics	Maximum Change	Test Method			
Temperature Coefficient	As specified	MIL-R-55342E Par 4.7.9 (-55°C + 125°C)			
Thermal Shock	±(0.5% + 0.01Ω)	MIL-R-55342E Par 4.7.3 (-65°C + 150°C, 5 cycles)			
Low Temperature Operation	±(0.25% + 0.01Ω)	MIL-R-55342E Par 4.7.4 (-65°C @ working voltage)			
Short Time Overload	±(1.0% + 0.01Ω)	MIL-R-55342E Par 4.7.5 2.5 x √PxR for 5 seconds			
High Temperature Exposure	±(0.5% + 0.01Ω)	MIL-R-55342E Par 4.7.6 (+150°C for 100 hours)			
Resistance to Bonding Exposure	±(0.25% + 0.01Ω)	MIL-R-55342E Par 4.7.7 (Reflow soldered to board at 260°C for 10 seconds)			
Solderability	95% minimum coverage	MIL-STD-202, Method 208 (245°C for 5 seconds)			
Moisture Resistance	±(0.5% + 0.01Ω)	MIL-R-55342E Par 4.7.8 (10 cycles, total 240 hours)			
Life Test	±(1.0% + 0.01Ω)	MIL-R-55342E Par 4.7.10 (2000 hours @ 70°C intermittent)			
Terminal Adhesion Strength	$\pm (1\% + 0.01\Omega)$ no mechanical damage	1200 gram push from underside of mounted chip for 60 seconds			
Resistance to Board Bending	$\pm (1\% + 0.01\Omega)$ no mechanical damage	Chip mounted in center of 90mm long board, deflected 5mm so as to exert pull on chip contacts for 10 seconds			

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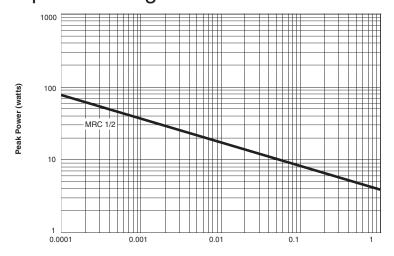




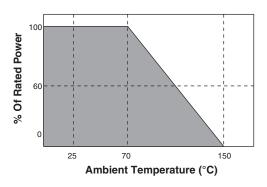
Physical Data



Repetitive Surge Curve



Power Derating Curve



Surge or Pulse Duration (seconds)

Note: Use for repetitive pulses where the average power dissipation is not to exceed the component rating at 70°C . Surge handling capacity for low-repetitive surges may be significantly greater than shown above. Contact factory for recommendations.

Ordering Data

